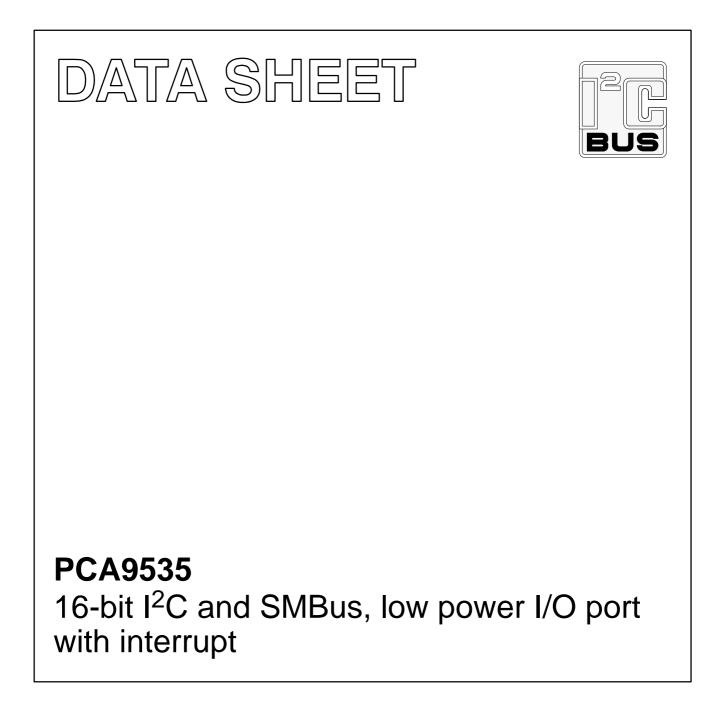
INTEGRATED CIRCUITS



Product data

2003 Jun 27



PCA9535



FEATURES

- Operating power supply voltage range of 2.3 V-5.5 V
- 5 V tolerant I/Os
- Polarity inversion register
- Active LOW interrupt output
- Low stand-by current
- Noise filter on SCL/SDA inputs
- No glitch on power-up
- Internal power-on reset
- 16 I/O pins which default to 16 inputs
- 0 to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115, and 1000 V CDM per JESD22-C101
- Latch-up testing is done to JESDEC Standard JESD78 which exceeds 100 mA
- Offered in three different packages: SO24, TSSOP24, and HVQFN24

DESCRIPTION

The PCA9535 is a 24-pin CMOS device that provide 16 bits of General Purpose parallel Input/Output (GPIO) expansion for

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	TOPSIDE MARK	DRAWING NUMBER
24-Pin Plastic SO	-40 to +85 °C	PCA9535D	PCA9535D	SOT137-1
24-Pin Plastic TSSOP	-40 to +85 °C	PCA9535PW	PCA9535PW	SOT355-1
24-Pin Plastic HVQFN	-40 to +85 °C	PCA9535BS	9535	SOT616-1

Standard packing quantities and other packing data are available at www.philipslogic.com/packaging.

I²C is a trademark of Philips Semiconductors Corporation.

SMBus as specified by the Smart Battery System Implementers Forum is a derivative of the Philips I²C patent.

I²C/SMBus applications and was developed to enhance the Philips family of I²C I/O expanders. The improvements include higher drive capability, 5 V I/O tolerance, lower supply current, individual I/O configuration, and smaller packaging. I/O expanders provide a simple solution when additional I/O is needed for ACPI power switches, sensors, pushbuttons, LEDs, fans, etc.

The PCA9535 consist of two 8-bit Configuration (Input or Output selection); Input, Output and Polarity inversion (Active HIGH or Active LOW operation) registers. The system master can enable the I/Os as either inputs or outputs by writing to the I/O configuration bits. The data for each Input or Output is kept in the corresponding Input or Output register. The polarity of the read register can be inverted with the Polarity Inversion Register. All registers can be read by the system master. Although pin-to-pin and I²C address compatible with the PCF8575, software changes are required due to the enhancements and are discussed in Application Note AN469.

The PCA9535 is identical to the PCA9555 except for the removal of the internal I/O pull-up resistor which greatly reduces power consumption when the I/Os are held LOW.

The PCA9535 open-drain interrupt output is activated when any input state differs from its corresponding input port register state and is used to indicate to the system master that an input state has changed. The power-on reset sets the registers to their default values and initializes the device state machine.

Three hardware pins (A0, A1, A2) vary the fixed I^2C address and allow up to eight devices to share the same $I^2C/SMBus$. The fixed I^2C address of the PCA9535 is the same as the PCA9554 allowing up to eight of these devices in any combination to share the same $I^2C/SMBus$.

PCA9535

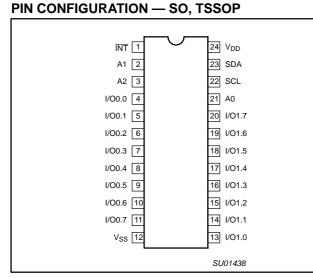
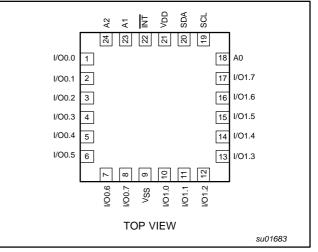


Figure 1. Pin configuration — SO, TSSOP

PIN DESCRIPTION

SO, TSSOP PIN NUMBER	HVQFN PIN NUMBER	SYMBOL	FUNCTION
1	22	INT	Interrupt output (open drain)
2	23	A1	Address input 1
3	24	A2	Address input 2
4-11	1-8	I/O0.0-I/O0.7	I/O0.0 to I/O0.7
12	9	V _{SS}	Supply ground
13-20	10-17	I/01.0-I/01.7	I/O1.0 to I/O1.7
21	18	A0	Address input 0
22	19	SCL	Serial clock line
23	20	SDA	Serial data line
24	21	V _{DD}	Supply voltage

PIN CONFIGURATION — HVQFN





PCA9535

BLOCK DIAGRAM

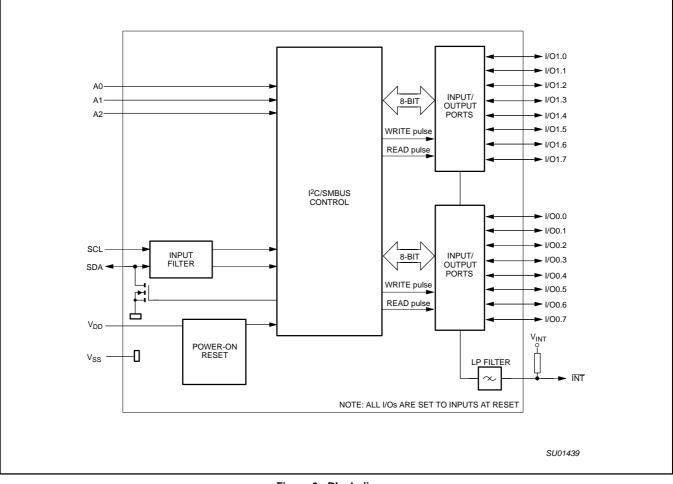
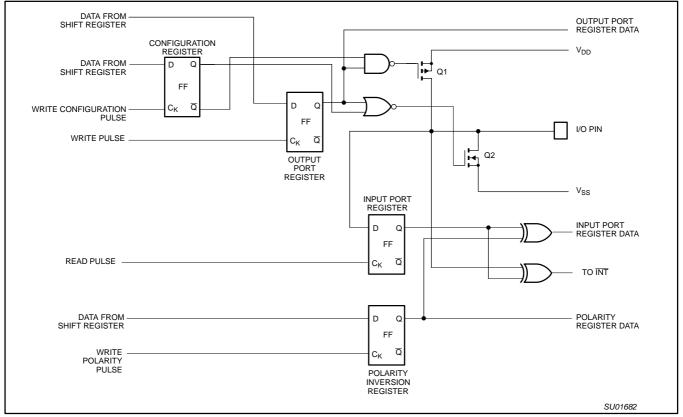


Figure 3. Block diagram

PCA9535

SIMPLIFIED SCHEMATIC OF I/Os



NOTE: At Power-on Reset, all registers return to default values.

Figure 4. Simplified schematic of I/Os

I/O port

When an I/O is configured as an input, FETs Q1 and Q2 are off, creating a high impedance input. The input voltage may be raised above V_{DD} to a maximum of 5.5 V.

If the I/O is configured as an output, then either Q1 or Q2 is on, depending on the state of the Output Port register. Care should be exercised if an external voltage is applied to an I/O configured as an output because of the low impedance path that exists between the pin and either V_{DD} or V_{SS}.

PCA9535

REGISTERS

Command Byte

Command	Register	
0	Input port 0	
1	Input port 1	
2	Output port 0	
3	Output port 1	
4	Polarity inversion port 0	
5	Polarity inversion port 1	
6	Configuration port 0	
7	Configuration port 1	

The command byte is the first byte to follow the address byte during a write transmission. It is used as a pointer to determine which of the following registers will be written or read.

Registers 0 and 1 — Input Port Registers

This register is an input-only port. It reflects the incoming logic levels of the pins, regardless of whether the pin is defined as an input or an output by Register 3. Writes to this register have no effect.

Registers 2 and 3 — Output Port Registers

bit	O0.7	O0.6	O0.5	00.4	O0.3	O0.2	00.1	O0.0
default	1	1	1	1	1	1	1	1
bit	01.7	01.6	01.5	01.4	01.3	01.2	01.1	01.0
default	1	1	1	1	1	1	1	1

This register is an output-only port. It reflects the outgoing logic levels of the pins defined as outputs by Register 6 and 7. Bit values in this register have no effect on pins defined as inputs. In turn, reads from this register reflect the value that is in the flip-flop controlling the output selection, NOT the actual pin value.

Registers 4 and 5 — Polarity Inversion Registers

bit	N0.7	N0.6	N0.5	N0.4	N0.3	N0.2	N0.1	N0.0
default	0	0	0	0	0	0	0	0
bit	N1.7	N1.6	N1.5	N1.4	N1.3	N1.2	N1.1	N1.0
default	0	0	0	0	0	0	0	0

This register allows the user to invert the polarity of the Input Port register data. If a bit in this register is set (written with '1'), the Input Port data polarity is inverted. If a bit in this register is cleared (written with a '0'), the Input Port data polarity is retained.

Registers 6 and 7 — Configuration Registers

bit	C0.7	C0.6	C0.5	C0.4	C0.3	C0.2	C0.1	C0.0
default	1	1	1	1	1	1	1	1
bit	C1.7	C1.6	C1.5	C1.4	C1.3	C1.2	C1.1	C1.0
default	1	1	1	1	1	1	1	1

This register configures the directions of the I/O pins. If a bit in this register is set (written with '1'), the corresponding port pin is enabled as an input with high impedance output driver. If a bit in this register is cleared (written with '0'), the corresponding port pin is enabled as an output. At reset the device's ports are inputs.

POWER-ON RESET

When power is applied to V_{DD} , an internal power-on reset holds the PCA9535 in a reset state until V_{DD} has reached V_{POR} . At that point, the reset condition is released and the PCA9535 registers and SMBus state machine will initialize to their default states.

DEVICE ADDRESS

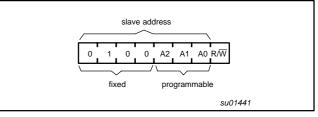


Figure 5. PCA9535 address

BUS TRANSACTIONS

Writing to the port registers

Data is transmitted to the PCA9535 by sending the device address and setting the least significant bit to a logic 0 (see Figure 5 for device address). The command byte is sent after the address and determines which register will receive the data following the command byte.

The eight registers within the PCA9535 are configured to operate as four register pairs. The four pairs are Input Ports, Output Ports, Polarity Inversion Ports, and Configuration Ports. After sending data to one register, the next data byte will be sent to the other register in the pair (see Figures 6 and 7). For example, if the first byte is sent to Output Port (register 3), then the next byte will be stored in Output Port 0 (register 2). There is no limitation on the number of data bytes sent in one write transmission. In this way, each 8-bit register may be updated independently of the other registers.

Reading the port registers

In order to read data from the PCA9535, the bus master must first send the PCA9535 address with the least significant bit set to a logic 0 (see Figure 5 for device address). The command byte is sent after the address and determines which register will be accessed. After a restart, the device address is sent again but this time, the least significant bit is set to a logic 1. Data from the register defined by the command byte will then be sent by the PCA9535 (see Figures 8, 9, and 10). Data is clocked into the register on the falling edge of the acknowledge clock pulse. After the first byte is read, additional bytes may be read but the data will now reflect the information in the other register in the pair. For example, if you read Input Port 1, then the next byte read would be Input Port 0. There is no limitation on the number of data bytes received in one read transmission but the final byte received, the bus master must not acknowledge the data.

Interrupt Output

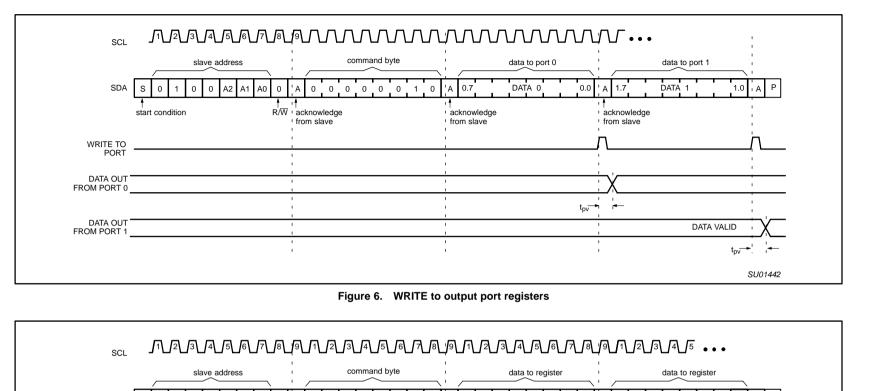
The open-drain interrupt output is activated when one of the port pins change state and the pin is configured as an input. The interrupt is deactivated when the input returns to its previous state or the input port register is read (see Figure 9). A pin configured as an output cannot cause an interrupt. Since each 8-bit port is read independently, the interrupt caused by Port 0 will not be cleared by a read of Port 1 or the other way around.

Note that changing an I/O from an output to an input may cause a false interrupt to occur if the state of the pin does not match the contents of the Input Port register.



16-bit I²C

Product data



R/W ¦acknowledge from slave

0

0 0

0 0

1 1 0

Figure 7. WRITE to configuration registers

A MSB

acknowledge

from slave

DATA 0

LSB

A MSB

acknowledge

from slave

DATA 1

LSB

Р

Α

SU01443

s

0

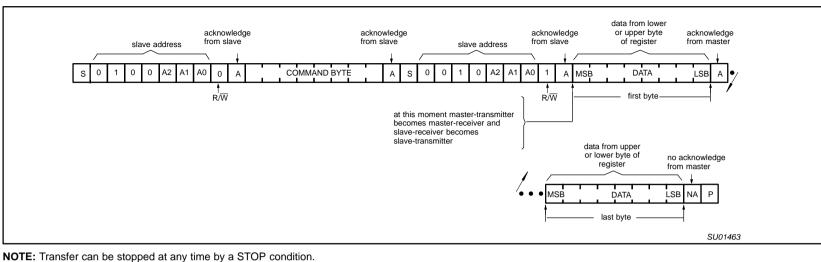
start condition

0 0

SDA

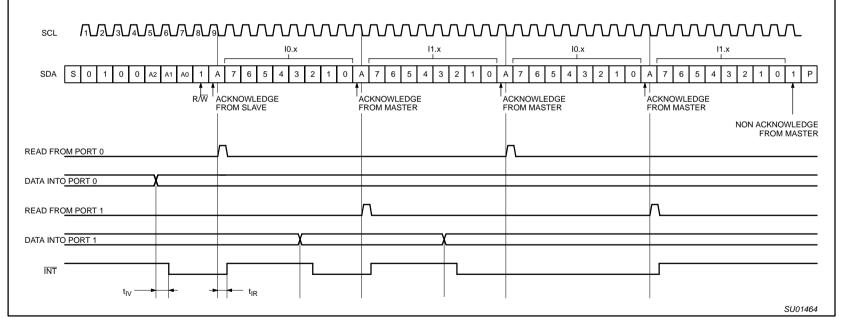
A2 A1 A0 0





ω





NOTES: Transfer of data can be stopped at any moment by a STOP condition. When this occurs, data present at the latest acknowledge phase is valid (output mode). It is assumed that the command byte has previously been set to 00 (read input port port register).

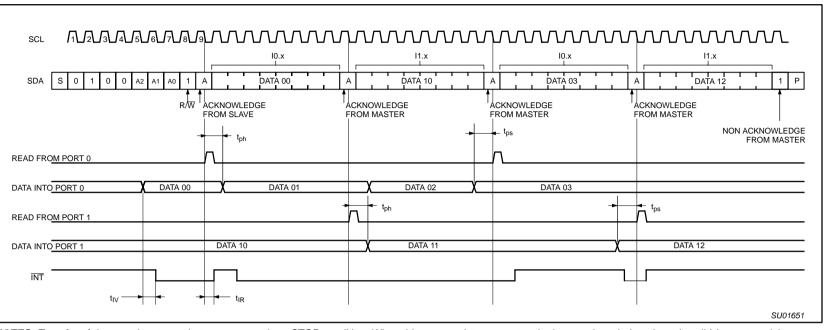
Figure 9. READ input port register — scenario 1

Philips Semiconductors 16-bit I²C and SMBus, low power I/O port with interrupt

Product data

PCA9535





NOTES: Transfer of data can be stopped at any moment by a STOP condition. When this occurs, data present at the latest acknowledge phase is valid (output mode). It is assumed that the command byte has previously been set to 00 (read input port port register).

Figure 10. READ input port register — scenario 2

16-bit I²C

and

SMBus,

low power I/O

Product data

PCA9535

TYPICAL APPLICATION

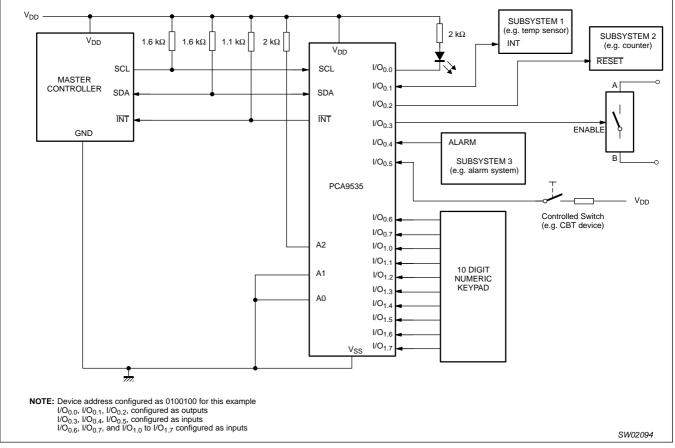


Figure 11. Typical application

Minimizing I_{DD} when the I/O is used to control LEDs

When the I/Os are used to control LEDs, they are normally connected to V_{DD} through a resistor as shown in Figure 11. Since the LED acts as a diode, when the LED is off the I/O V_{IN} is about 1.2 V less than V_{DD} . The supply current, I_{DD} , increases as V_{IN} becomes lower than V_{DD} and is specified as ΔI_{DD} in the DC characteristics table.

Designs needing to minimize current consumption, such as battery power applications, should consider maintaining the I/O pins greater than or equal to V_{DD} when the LED is off. Figure 12 shows a high value resistor in parallel with the LED. Figure 13 shows V_{DD} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the I/O V_{IN} at or above V_{DD} and prevents additional supply current consumption when the LED is off.

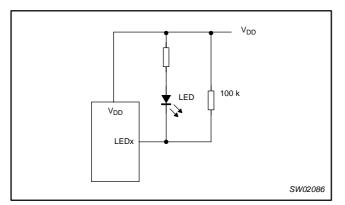


Figure 12. High value resistor in parallel with the LED

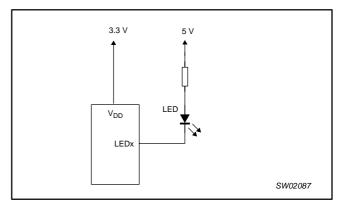


Figure 13. Device supplied by a lower voltage

PCA9535

ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V _{DD}	Supply voltage		-0.5	6.0	V
V _{I/O}	DC input current on an I/O		V _{SS} - 0.5	6	V
I _{I/O}	DC output current on an I/O		—	± 50	mA
l	DC input current		—	± 20	mA
I _{DD}	Supply current		—	160	mA
I _{SS}	Supply current		—	200	mA
P _{tot}	Total power dissipation		—	200	mW
T _{stg}	Storage temperature range		-65	+150	°C
T _{amb}	Operating ambient temperature		-40	+85	°C

PCA9535

HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is desirable to take precautions appropriate to handling MOS devices. Advice can be found in Data Handbook IC24 under "Handling MOS devices".

DC CHARACTERISTICS

 V_{DD} = 2.3 to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 to +85 $^\circ C$; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Supplies		•				
V _{DD}	Supply voltage		2.3		5.5	V
I _{DD}	Supply current	Operating mode; V_{DD} = 5.5 V; no load; f_{SCL} = 100 kHz; I/O = inputs	—	135	200	μA
I _{stbl}	Standby current	Standby mode; V_{DD} = 5.5 V; no load; V _I = V _{SS} ; f _{SCL} = 0 kHz; I/O = inputs	-	0.25	1	μΑ
I _{stbh}	Standby current	Standby mode; $V_{DD} = 5.5$ V; no load; $V_I = V_{DD}$; $f_{SCL} = 0$ kHz; I/O = inputs	-	0.25	1	μA
V _{POR}	Power-on reset voltage	No load; $V_I = V_{DD}$ or V_{SS}	—	1.5	1.65	V
input SCL;	input/output SDA		-	-		
VIL	LOW-level input voltage		-0.5		0.3 V _{DD}	V
VIH	HIGH-level input voltage		0.7 V _{DD}		5.5	V
I _{OL}	LOW-level output current	$V_{OL} = 0.4V$	3		—	mA
١L	Leakage current	$V_{I} = V_{DD} = V_{SS}$	-1	_	+1	μA
Cl	Input capacitance	$V_{I} = V_{SS}$	—	6	10	pF
I/Os					•	
VIL	LOW-level input voltage		-0.5		0.8	V
VIH	HIGH-level input voltage		2.0	_	5.5	V
		V _{OL} = 0.5 V; V _{DD} = 2.3-5.5 V; Note 1	8	8-20	—	mA
I _{OL}	LOW-level output current	V _{OL} = 0.7 V; V _{DD} = 2.3-5.5 V; Note 1	10	10-24	—	mA
		I _{OH} = -8 mA; V _{DD} = 2.3 V; Note 2	1.8	_	—	V
		I _{OH} = -10 mA; V _{DD} = 2.3 V; Note 2	1.7		—	V
		I _{OH} = -8 mA; V _{DD} = 3.0 V; Note 2	2.6			V
V _{OH}	HIGH-level output voltage	I _{OH} = -10 mA; V _{DD} = 3.0 V; Note 2	2.5		_	V
		I _{OH} = -8 mA; V _{DD} = 4.75 V; Note 2	4.1			V
		I _{OH} = -10 mA; V _{DD} = 4.75 V; Note 2	4.0		_	V
I _{IH}	Input leakage current	$V_{DD} = 5.5 \text{ V}; \text{ V}_{I} = V_{DD}$	—	_	1	μA
IIL	Input leakage current	$V_{DD} = 5.5 \text{ V}; \text{ V}_{I} = V_{SS}$	—		-1	μA
Cl	Input capacitance		—	3.7	5	pF
CO	Output capacitance		—	3.7	5	pF
Interrupt IN	Τ		-	-		
I _{OL}	LOW-level output current	$V_{OL} = 0.4 V$	3			mA
Select Inpu	ts A0, A1, A2					
V _{IL}	LOW-level input voltage		-0.5	_	0.8	V
VIH	HIGH-level input voltage		2.0	—	5.5	V
ILI	Input leakage current		-1	_	1	μA

NOTES:

1. The total current sunk by all I/Os must be limited to 200 mA.

2. The total current sourced by all I/Os must be limited to 160 mA.

PCA9535

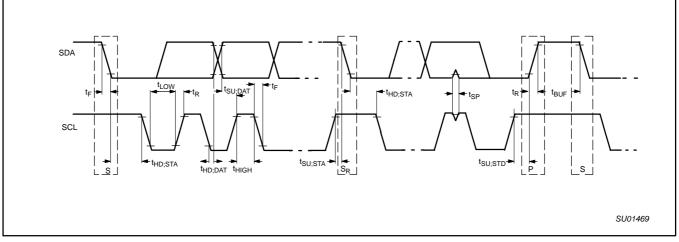


Figure 14. Definition of timing

AC CHARACTERISTICS

SYMBOL	PARAMETER		RD MODE BUS	FAST M I ² C BI	UNITS	
		MIN	MAX	MIN	MAX	
f _{SCL}	Operating frequency	0	100	0	400	kHz
t _{BUF}	Bus free time between STOP and START conditions	4.7	—	1.3	_	μs
t _{HD;STA}	Hold time after (repeated) START condition	4.0	—	0.6	_	μs
t _{SU;STA}	Repeated START condition setup time	4.7	—	0.6	_	μs
t _{SU;STO}	Set-up time for STOP condition	4.0	—	0.6	_	μs
t _{VD;ACK}	Valid time of ACK condition ²	0.3	3.45	0.1	0.9	μs
t _{HD;DAT}	Data in hold time	0	—	0	_	ns
t _{VD;DAT}	Data out valid time ³	300	—	50	_	ns
t _{SU;DAT}	Data set-up time	250	—	100	_	ns
t _{LOW}	Clock LOW period	4.7	—	1.3	_	μs
thigh	Clock HIGH period	4.0	—	0.6	_	μs
t _F	Clock/Data fall time	_	300	20 + 0.1C _b ¹	300	ns
t _R	Clock/Data rise time	_	1000	20 + 0.1C _b ¹	300	ns
t _{SP}	Pulse width of spikes that must be suppressed by the input filters	-	50	—	50	ns
Port Timing			-			
t _{PV}	Output data valid	_	200		200	ns
t _{PS}	Input data set-up time	150	—	150	—	ns
t _{PH}	Input data hold time	1	—	1	_	μs
Interrupt Ti	ming					
t _{IV}	Interrupt valid	—	4	—	4	μs
t _{IR}	Interrupt reset	—	4		4	μs

NOTES:

1. C_b = total capacitance of one bus line in pF. 2. $t_{VD;ACK}$ = time for Acknowledgement signal from SCL LOW to SDA (out) LOW. 3. $t_{VD;DAT}$ = minimum time for SDA data out to be valid following SCL LOW. 4. t_{PV} measured from 0.7V_{DD} on SCL to 50% I/O output.

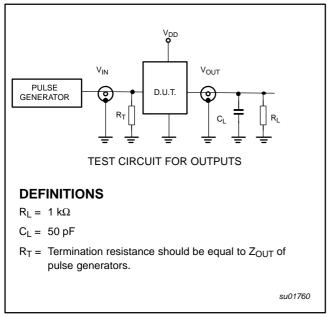


Figure 15. t_{PV} set-up conditions

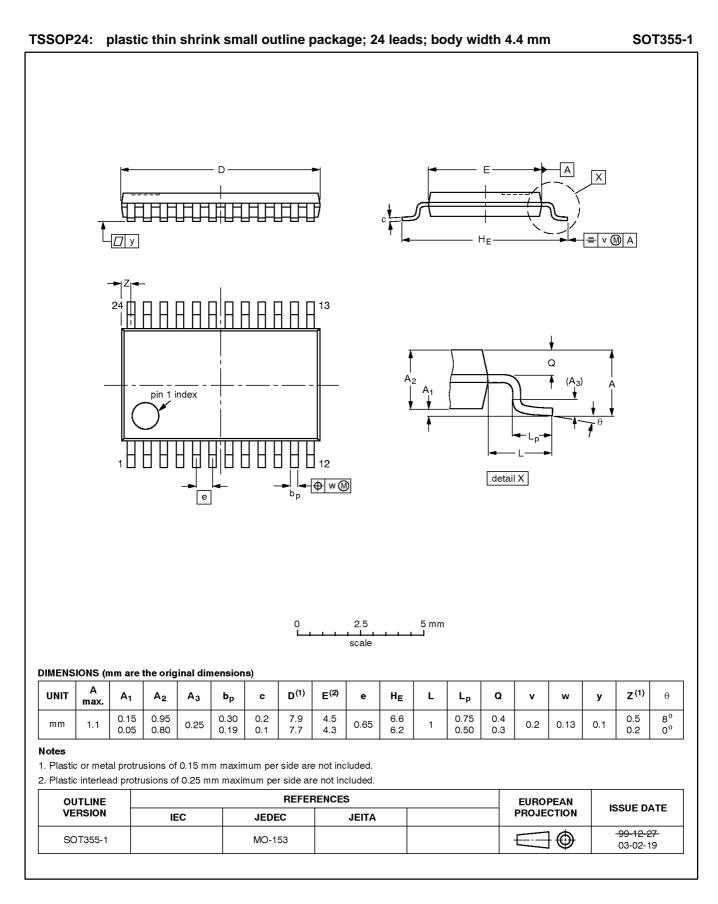
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16-bit I²C and SMBus, low power I/O port with interrupt

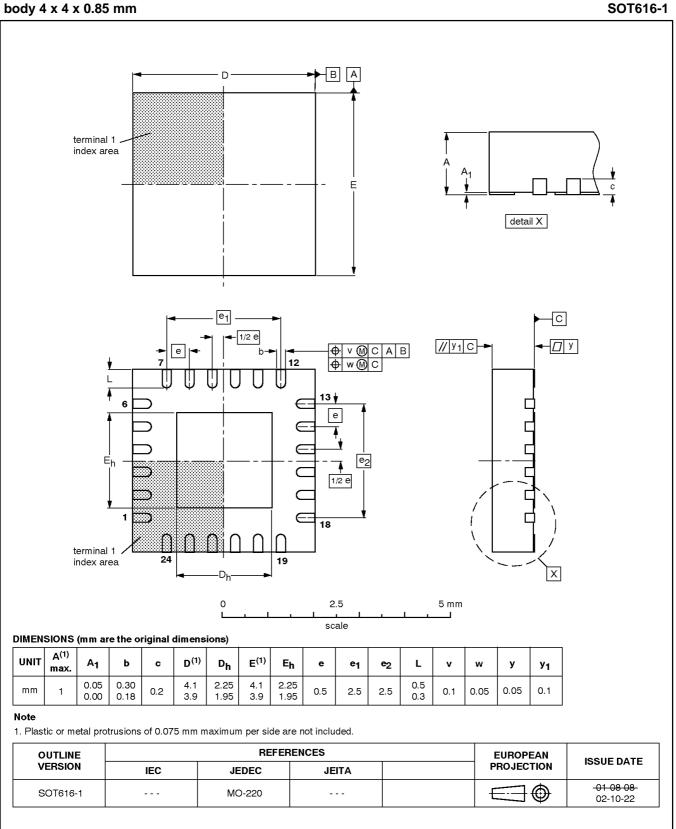
SO24: plastic small outline package; 24 leads; body width 7.5 mm SOT137-1 А Х = v (M) A Ду 13 Q pin 1 index 🗖 12 detail X e < + ♥ w ₪ bp 10 mm 5 0 scale DIMENSIONS (inch dimensions are derived from the original mm dimensions) Α E⁽¹⁾ D ⁽¹⁾ z⁽¹⁾ UNIT Lp θ A₁ A_2 A₃ bp С HE L Q ۷ w У е max. 0.3 2.45 0.49 0.32 15.6 7.6 10.65 0.9 1.1 1.1 2.65 mm 0.25 1.27 1.4 0.25 0.25 0.1 2.25 10.00 1.0 0.4 0.1 0.36 0.23 15.2 7.4 0.4 8° 0⁰ 0.012 0.096 0.019 0.013 0.61 0.30 0.419 0.043 0.043 0.035 0.05 inches 0.1 0.004 0.01 0.055 0.01 0.01 0.016 0.004 0.089 0.014 0.009 0.60 0.29 0.394 0.016 0.039 Note 1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included. REFERENCES OUTLINE EUROPEAN **ISSUE DATE** VERSION PROJECTION IEC JEDEC JEITA -99-12-27 ۲ SOT137-1 075E05 MS-013 E 03-02-19

PCA9535



PCA9535

16-bit I²C and SMBus, low power I/O port with interrupt



HVQFN24: plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body 4 x 4 x 0.85 mm

PCA9535

REVISION HISTORY

Rev	Date	Description
_1	20030627	Product data (9397 750 11681); ECN 853-2430 30019 dated 11 June 2003. Initial version

PCA9535

16-bit I²C and SMBus, low power I/O port with interrupt



Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specifications defined by Philips. This specification can be ordered using the code 9398 393 40011.

Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2] [3]}	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
111	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Date of release: 06-03

9397 750 11681

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Document order number:



